

Product Summary (@ T_A = +25°C)

V _{RRM} (V)	I _O (A)	V _{F(MAX)} (V)	I _{R(MAX)} (μA)
600,1000	1	1.7	5

Description and Applications

The US1JDF and US1MDF are rectifiers packaged in the low profile D-FLAT package. Providing ultra-fast recovery time for high efficiency, this device is ideal for use in general rectification applications such as:

- Switching Mode Power Supply
- DC-DC Converter

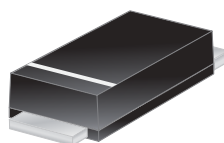
Features and Benefits

- Glass Passivated Die Construction
- Ultra-Fast Recovery Time for High Efficiency
- Surge Overload Rating to 30A Peak
- High Current Capability
- Low Profile Design, Package Height Less than 1.1mm
- **Lead-Free Finish; RoHS Compliant (Notes 1 & 2)**
- **Halogen and Antimony Free. "Green" Device (Note 3)**

Mechanical Data

- Case: D-FLAT
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish - Matte Tin Annealed over Copper Leadframe. Solderable per MIL-STD-202, Method 208 
- Polarity: Cathode Band
- Weight: 0.064 grams (Approximate)

D-FLAT

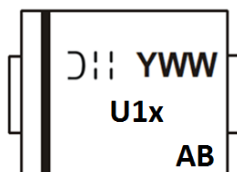


Top View

Ordering Information (Note 4)

Part Number	Qualification	Case	Packaging
US1JDF-13	Commercial	D-FLAT	10,000/Tape & Reel
US1MDF-13	Commercial	D-FLAT	10,000/Tape & Reel

- Notes:
1. EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant. All applicable RoHS exemptions applied.
 2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
 4. For packaging details, go to our website at <http://www.diodes.com/products/packages.html>.

Marking Information


U1J or U1M = Product Type Marking Code
 = Manufacturers' Code Marking
 YWW = Date Code Marking
 Y = Last Digit of Year (ex: 4 for 2014)
 WW = Week Code (01 to 53)
 AB = Foundry and Assembly Code

Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Single phase, half wave, 60Hz, resistive or inductive load.
 For capacitance load, derate current by 20%.

Characteristic	Symbol	US1JDF	US1MDF	Unit
Peak Repetitive Reverse Voltage	V _{RRM}	600	1000	V
Working Peak Reverse Voltage	V _{RWM}			
DC Blocking Voltage (Note 5)	V _R			
RMS Reverse Voltage	V _{R(RMS)}	420	700	V
Average Rectified Output Current @T _T = +25°C	I _O	1.0		A
Non-Repetitive Peak Forward Surge Current 8.3ms Single Half Sine-Wave Superimposed on Rated Load	I _{FSM}	30		A

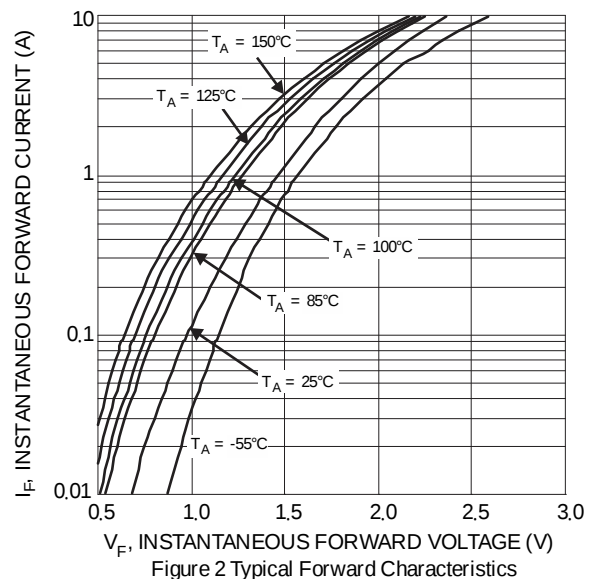
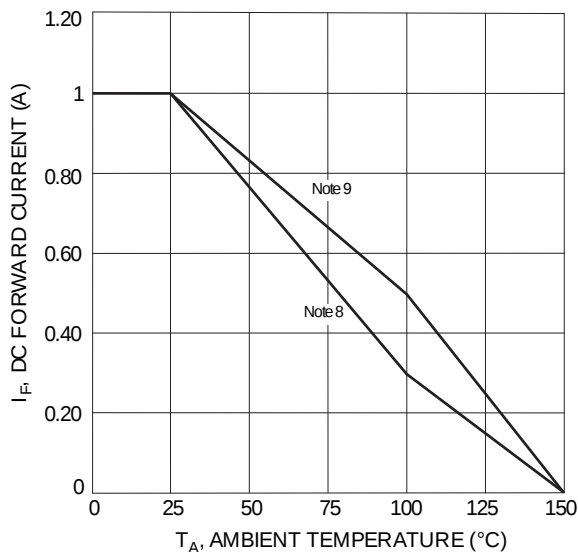
Thermal Characteristics

Characteristic	Symbol	Value	Unit
Typical Thermal Resistance, Junction to Terminal (Note 8)	R _{θJT}	44	°C/W
Typical Thermal Resistance, Junction to Ambient (Note 8)	R _{θJA}	80	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-55 to +150	°C

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	US1JDF	US1MDF	Unit
Minimum Reverse Breakdown Voltage (Note 5) @I _R = 5μA	V _{(BR)R}	600	1000	V
Maximum Forward Voltage Drop @ I _F = 1.0A	V _F	1.7		V
Peak Reverse Current @T _A = +25°C	I _R	5.0		μA
at Rated DC Blocking Voltage (Note 5) @T _A = +100°C		100		
Maximum Reverse Recovery Time (Note 6)	t _{rr}	75		ns
Typical Total Capacitance (Note 7)	C _T	10		pF

- Notes:
5. Short duration pulse test used to minimize self-heating effect.
 6. Measured with I_F = 0.5A, I_R = 1.0A, I_{rr} = 0.25A. See figure 7.
 7. Measured at 1.0MHz and applied reverse voltage of 4.0V DC.
 8. Device mounted on FR-4 substrate, 1" * 1", 2oz, single-sided, PC boards with 0.1" * 0.15" copper pads.
 9. Device mounted on FR-4 substrate, 0.4" * 0.5", 2oz, single-sided, PC boards with 0.2" * 0.25" copper pads.



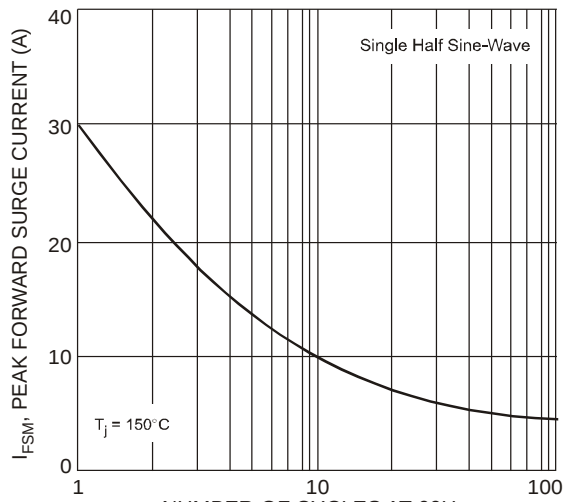


Fig. 3 Forward Surge Current Derating Curve

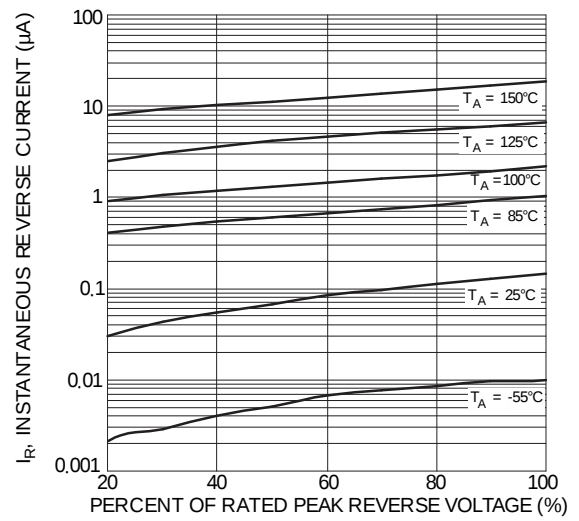


Figure 4 Typical Reverse Characteristics

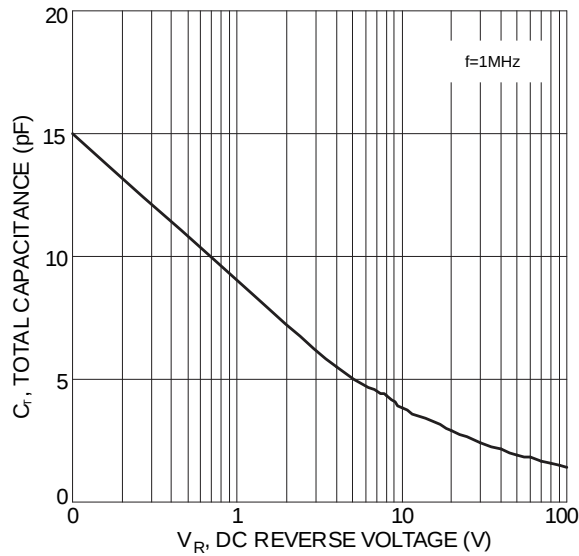


Figure 5 Total Capacitance

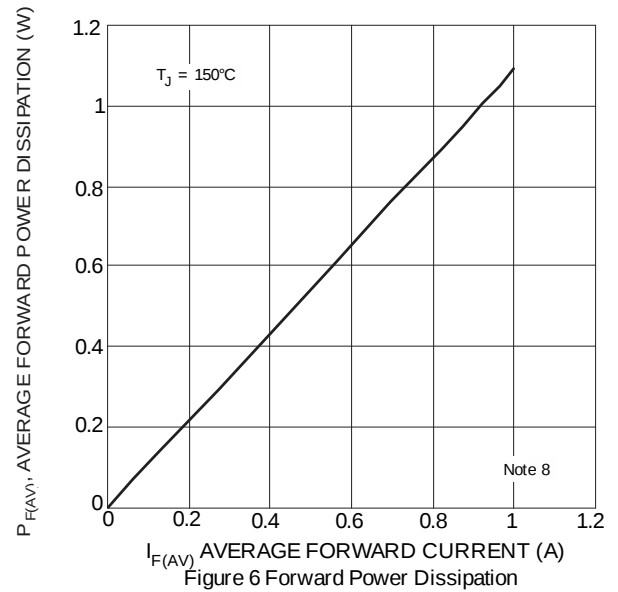
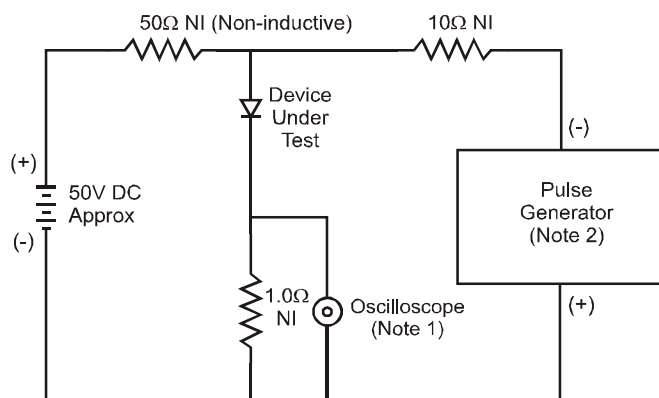
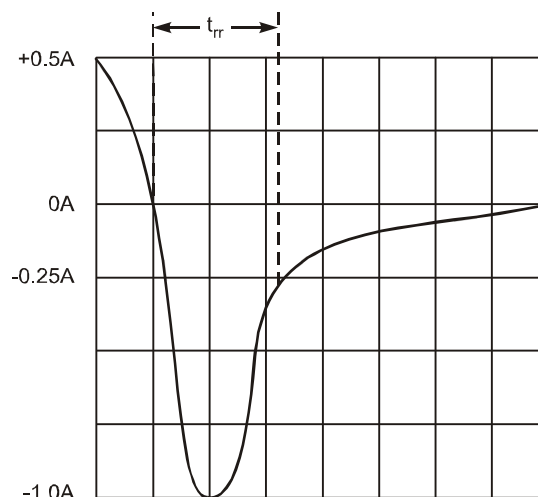


Figure 6 Forward Power Dissipation



Notes:

1. Rise Time = 7.0ns max. Input Impedance = 1.0MΩ, 22pF.
2. Rise Time = 10ns max. Input Impedance = 50Ω.

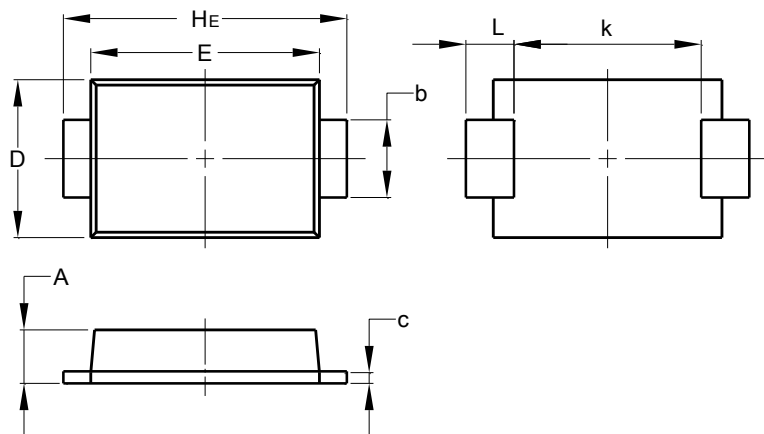


Set time base for 50/100 ns/cm

Fig. 7 Reverse Recovery Time Characteristic and Test Circuit

Package Outline Dimensions

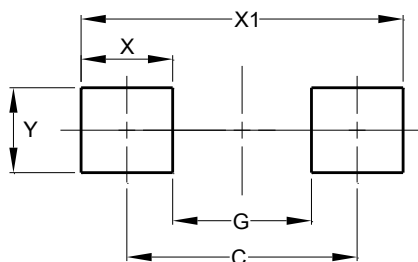
Please see AP02002 at <http://www.diodes.com/datasheets/ap02002.pdf> for the latest version.



D-FLAT		
Dim	Min	Max
A	0.90	1.10
b	1.25	1.65
c	0.10	0.40
D	2.25	2.95
E	3.95	4.60
k	2.80	-
HE	5.00	5.60
L	0.50	1.30
All Dimensions in mm		

Suggested Pad Layout

Please see AP02001 at <http://www.diodes.com/datasheets/ap02001.pdf> for the latest version.



Dimensions	Value (in mm)
C	4.65
G	2.80
X	1.85
X1	6.50
Y	1.70

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